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IN THE CLAIMS:

1 (currently amended): A surface acoustic wave device comprising a piezoelectric substrate and an IDT that is formed on said piezoelectric substrate and is made from Al or alloy including Al as a main component, an excited wave being an SH wave, wherein

said piezoelectric substrate is <u>a rotation Y cut substrate made from</u> a quartz flat [[plate]] <u>substrate</u>,

where a cut angle θ of a rotation Y cut quartz substrate said piezoelectric substrate is a rotation angle of a crystal Z-axis when the piezoelectric substrate is rotated around a crystal X-axis.

a direction in which the piezoelectric substrate is rotated from a positive Z-axis side to a positive Y-axis side is a direction in which said cut angle θ is minus, and

the cut angle θ is set in a range of -64.0°<0<-49.3° in a counterclockwise direction from a crystal-Z-axis, and a propagation direction of a SAW is set to (90°±5°) to a crystal X-axis, and

when a wavelength of the SAW to be excited is represented as λ , an electrode film thickness H/ λ standardized by a wavelength of said IDT is set to satisfy 0.04<H/ λ <0.12.

2 (original): The surface acoustic wave device according to claim 1, wherein a relationship between the cut angle θ and the electrode film thickness H/ λ satisfies - 1.34082×10⁻⁴× θ ³-2.34969×10⁻²× θ ²-1.37506× θ -26.7895<H/ λ <-1.02586×10⁻⁴× θ ³ - 1.73238×10⁻²× θ ²-0.977607× θ -18.3420.

3 (original): The surface acoustic wave device according to claim 1, wherein, when an electrode finger width of electrode fingers constituting said IDT/(electrode finger width + space between electrode fingers) is defined as a line metalization ratio mr, a

relationship between the cut angle θ and a product H/ λ ×mr of the electrode film thickness and the line metalization ratio satisfies -8.04489×10⁻⁵× θ ³-1.40981× 10^{-2} × θ ²-0.825038× θ -16.0737<H/ λ ×mr<-6.15517×10⁻⁵× θ ³-1.03943×10⁻²× θ ²-0.586564× θ -11.0052.

4 (currently amended): A surface acoustic wave device comprising a piezoelectric substrate and an IDT that is formed on said piezoelectric substrate and is made from Al or alloy including Al as a main component, an excited wave being utilized as an SH wave, wherein

said piezoelectric substrate is <u>a rotation Y cut substrate made from</u> a quartz flat [[plate]] <u>substrate</u>,

where a cut angle θ of a rotation Y cut quartz substrate said piezoelectric substrate is a rotation angle of a crystal Z-axis when the piezoelectric substrate is rotated around a crystal X-axis.

a direction in which the piezoelectric substrate is rotated from a positive Z-axis side to a positive Y-axis side is a direction in which said cut angle θ is minus, and

the cut angle θ is set to satisfy in a range of -61.4°< θ <-51.1° in a counterclockwise direction from a crystal Z axis, and a propagation direction of a SAW is set to (90°±5°) to a crystal X-axis, and

when a wavelength of the SAW to be excited is represented as λ , an electrode film thickness H/ λ standardized by a wavelength of the IDT is set to satisfy 0.05<H/ λ <0.10.

5 (original): The surface acoustic wave device according to claim 4, wherein a relationship between the cut angle θ and the electrode film thickness H/ λ satisfies - 1.44605×10⁻⁴× θ ³-2.50690×10⁻²× θ ²-1.45086× θ -27.9464<H/ λ <-9.87591×10⁻⁵× θ ³-1.70304×10⁻²× θ ²-0.981173× θ -18.7946.

6 (original): The surface acoustic wave device according to claim 4, wherein when an electrode finger width of electrode fingers constituting said IDT/(electrode finger width + space between electrode fingers) is defined as a line metalization ratio mr, a relationship between the cut angle θ and a product H/ λ ×mr of the electrode film thickness and the line metalization ratio satisfies -8.67632× $10^{-5}\times\theta^3$ -1.50414× $10^{-2}\times\theta^2$ -0.870514× θ -16.7678<H/ λ ×mr<-5.92554× $10^{-5}\times\theta^3$ -1.02183× $10^{-2}\times\theta^2$ -0.588704× θ -11.2768.

7 (original): The surface acoustic wave device according to any one of claims 1 to 6, wherein

said surface acoustic wave device is a one-port surface acoustic wave resonator where at least one IDT is disposed on said piezoelectric substrate.

8 (original): The surface acoustic wave device according to any one of claims 1 to 6, wherein

said surface acoustic wave device is a two-port surface acoustic wave resonator where at least two IDTs are disposed along a propagation direction of a surface acoustic wave on said plezoelectric substrate.

9 (original): The surface acoustic wave device according to any one of claims 1 to 6, wherein

said surface acoustic wave device is a lateral coupling type multi-mode filter where a plurality of surface acoustic wave resonators are disposed in proximity to each other in parallel with a propagation direction of a surface acoustic wave on said piezoelectric substrate.

10 (original): The surface acoustic wave device according to any one of claims 1 to 6, wherein

said surface acoustic wave device is a vertical coupling type multi-mode filter where two-port surface acoustic wave resonators comprising a plurality of IDTs are disposed along a propagation direction of a surface acoustic wave on said piezoelectric substrate.

11 (original): The surface acoustic wave device according to any one of claims 1 to 6, wherein

said surface acoustic wave device is a ladder type surface acoustic wave filter where a plurality of surface acoustic wave resonators are connected on said piezoelectric substrate in a ladder shape.

12 (original): The surface acoustic wave device according to any one of claims 1 to 6, wherein

said surface acoustic wave device is a transversal SAW filter where a plurality of IDTs propagating a surface acoustic wave bidirectionally are disposed on said piezoelectric substrate at predetermined intervals.

13 (original): The surface acoustic wave device according to any one of claims 1 to 6, wherein

said surface acoustic wave device is a transversal SAW filter where at least one IDT propagating a surface acoustic wave in one direction is disposed on said piezoelectric substrate.

14 (original): The surface acoustic wave device according to any one of claims 1 to 6, wherein

said surface acoustic wave device is a surface acoustic wave sensor.

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15 (previously presented): The surface acoustic wave device according to any one of claims 1 to 6, wherein

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said surface acoustic wave device has grating reflectors on both sides of an IDT.

16 (previously presented): A module device or an oscillation circuit using the surface acoustic wave device according to any one of claims 1 to 6.